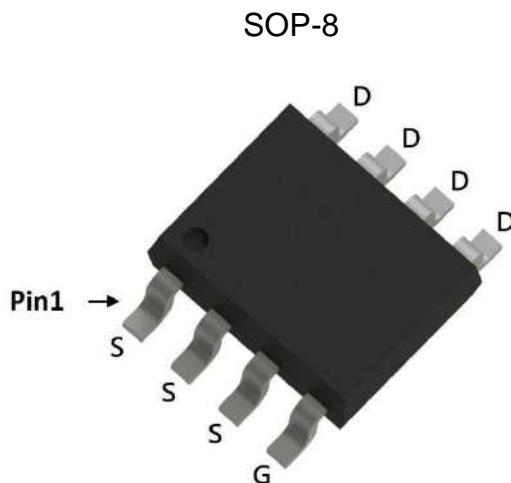


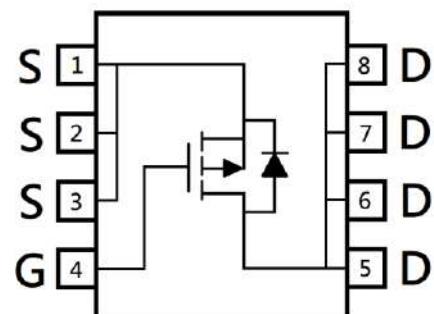
## P-Channel Enhancement Mode Power MOSFET

### Features:

- Low On Resistance
- Low Gate Charge
- Fast Switching Characteristic



BV <sub>DSS</sub>	-30V
I <sub>D</sub> @V <sub>GS</sub> =-10V, T <sub>C</sub> =25°C	-18A
I <sub>D</sub> @V <sub>GS</sub> =-10V, T <sub>A</sub> =25°C	-7.5A
R <sub>DSON</sub> (Typ.) @ V <sub>GS</sub> =-10V, I <sub>D</sub> =-7A	13mΩ
R <sub>DSON</sub> (Typ.) @ V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-5A	20mΩ



G : Gate S : Source D : Drain

Device	Package	Shipping
KSC4435A	SOP-8 (Pb-free lead plating and halogen-free package)	4000 pcs / Tape & Reel

### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ )

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	V <sub>DS</sub>	-30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	
Continuous Drain Current @ V <sub>GS</sub> =-10V, T <sub>C</sub> =25°C	I <sub>D</sub>	-18	A
Continuous Drain Current @ V <sub>GS</sub> =-10V, T <sub>C</sub> =100°C		-11	
Continuous Drain Current @ V <sub>GS</sub> =-10V, T <sub>A</sub> =25°C		-7.5	
Continuous Drain Current @ V <sub>GS</sub> =-10V, T <sub>A</sub> =70°C		-6	
Pulsed Drain Current	I <sub>DM</sub>	-72	
Continuous Body Diode Forward Current @ T <sub>C</sub> =25°C	I <sub>S</sub>	-9	
Avalanche Current @ L=0.1mH	I <sub>AS</sub>	-20	
Avalanche Energy @ L=0.5mH	E <sub>AS</sub>	30	mJ
Total Power Dissipation	T <sub>C</sub> =25°C	*a	W
	T <sub>C</sub> =100°C	*a	
	T <sub>A</sub> =25°C	*b	
	T <sub>A</sub> =70°C	*b	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55~+150	°C

### Thermal Data

Parameter	Symbol	Steady State	Unit
Thermal Resistance, Junction-to-case	R <sub>θJC</sub>	12	°C/W
Thermal Resistance, Junction-to-ambient	R <sub>θJA</sub>	71	

Note:

- \*a. The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- \*b. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR -4 board with 2 oz. copper, in a still air environment with T<sub>A</sub>=25°C. The power dissipation P<sub>D</sub> is based on R<sub>θJA</sub> and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.
- \*c. Repetitive rating, pulse width limited by junction temperature T<sub>J(MAX)</sub>=150°C. Ratings are based on low frequency and low duty cycles to keep initial T<sub>J</sub>=25°C.

### **Electrical Characteristics ( $T_A=25^\circ\text{C}$ , unless otherwise specified)**

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
<b>Static</b>					
BV <sub>DSS</sub>	-30	-	-	V	V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA
V <sub>GS(th)</sub>	-1	-	-2.5		V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA
G <sub>FS</sub>	-	12	-	S	V <sub>DS</sub> =-10V, I <sub>D</sub> =-5A
I <sub>GSS</sub>	-	-	±100	nA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
I <sub>DSS</sub>	-	-	-1	μA	V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V
R <sub>DSS(ON)</sub>	-	13	18	mΩ	V <sub>GS</sub> =-10V, I <sub>D</sub> =-7A
	-	20	28		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-5A
<b>Dynamic</b>					
C <sub>iss</sub>	-	1650	-	pF	V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, f=1MHz
C <sub>oss</sub>	-	195	-		
C <sub>rss</sub>	-	175	-		
R <sub>g</sub>	-	5	-	Ω	f=1MHz
Q <sub>g</sub> *1, 2	-	36	-	nC	V <sub>DS</sub> =-15V, I <sub>D</sub> =-7A, V <sub>GS</sub> =-10V
Q <sub>gs</sub> *1, 2	-	5.2	-		
Q <sub>gd</sub> *1, 2	-	7.8	-		
t <sub>d(ON)</sub> *1, 2	-	12	-	ns	V <sub>DS</sub> =-15V, I <sub>D</sub> =-7A, V <sub>GS</sub> =-10V, R <sub>GS</sub> =2.7Ω
t <sub>r</sub> *1, 2	-	19	-		
t <sub>d(OFF)</sub> *1, 2	-	70	-		
t <sub>f</sub> *1, 2	-	20	-		
<b>Source-Drain Diode</b>					
V <sub>SD</sub> *1	-	-0.83	-1.2	V	I <sub>S</sub> =-7A, V <sub>GS</sub> =0V
trr	-	15	-	ns	I <sub>F</sub> =-7A, dI <sub>F</sub> /dt=100A/μs
Qrr	-	6.4	-	nC	

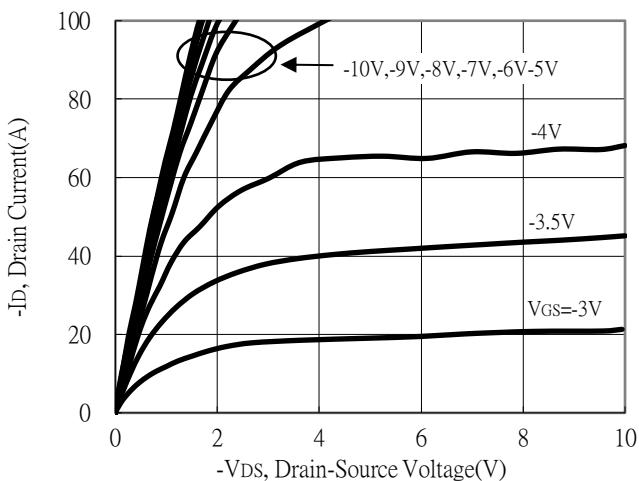
Note:

\*1. Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$

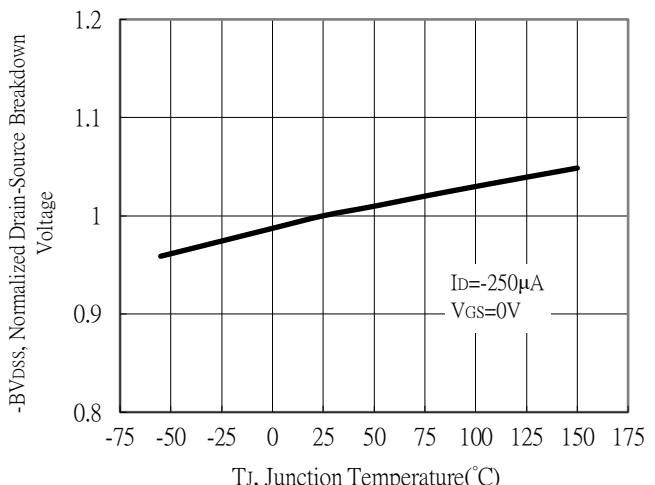
\*2. Independent of operating temperature

## Typical Characteristics

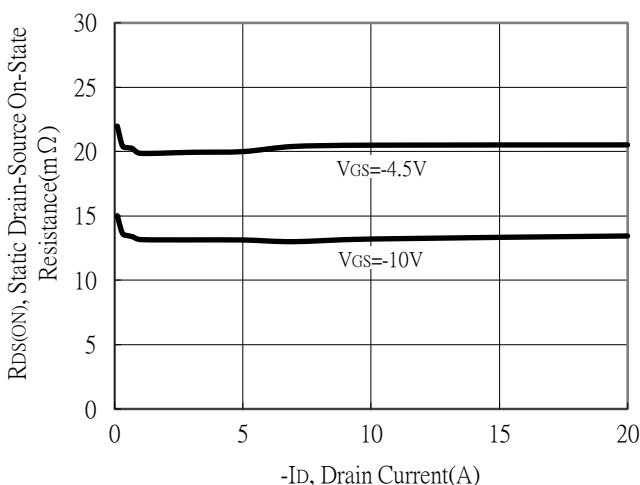
Typical Output Characteristics



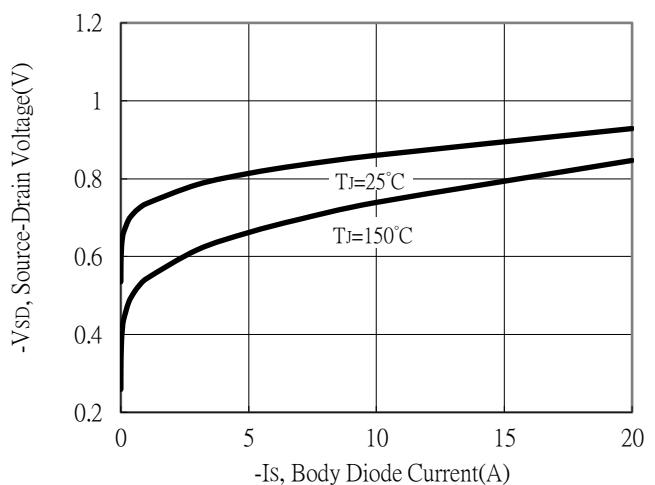
Breakdown Voltage vs Ambient Temperature



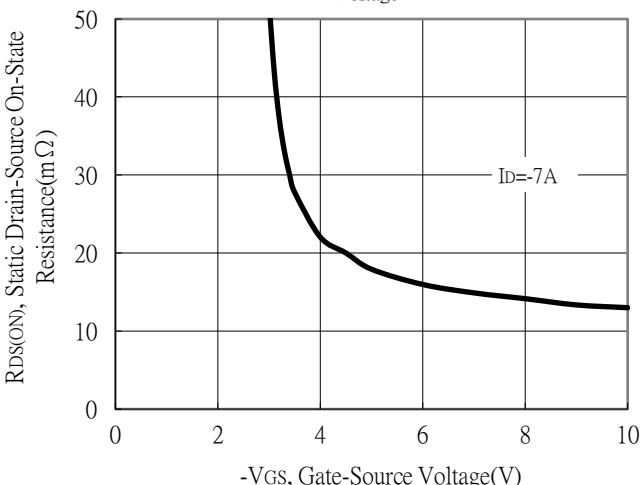
Static Drain-Source On-State resistance vs Drain Current



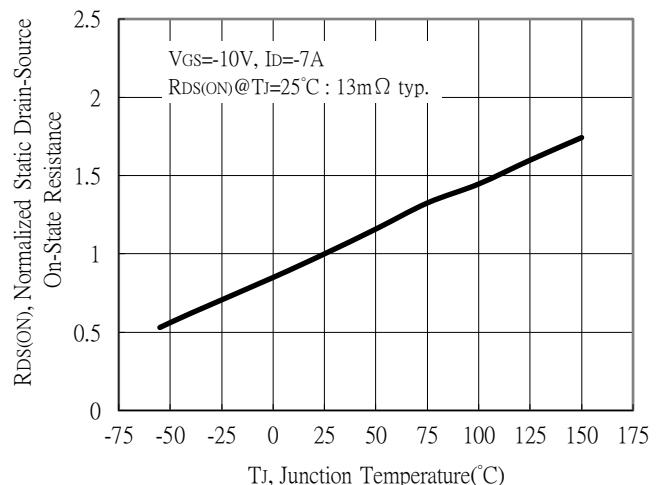
Body Diode Current vs Source-Drain Voltage



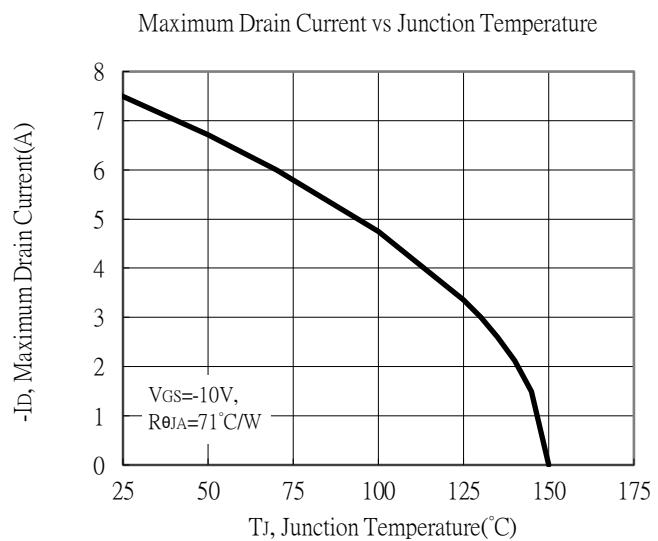
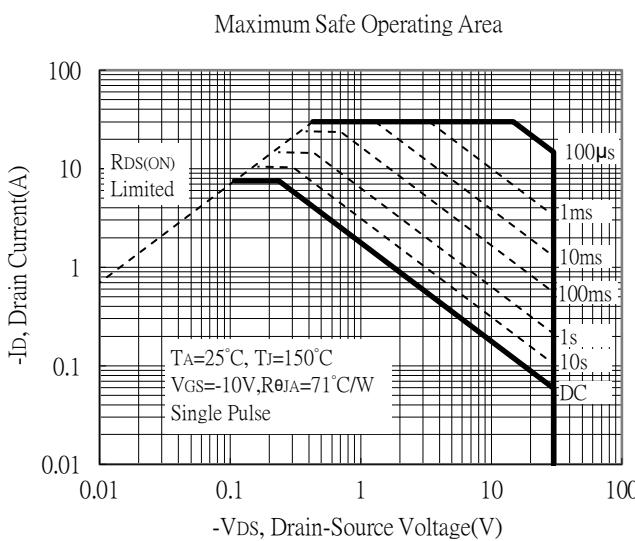
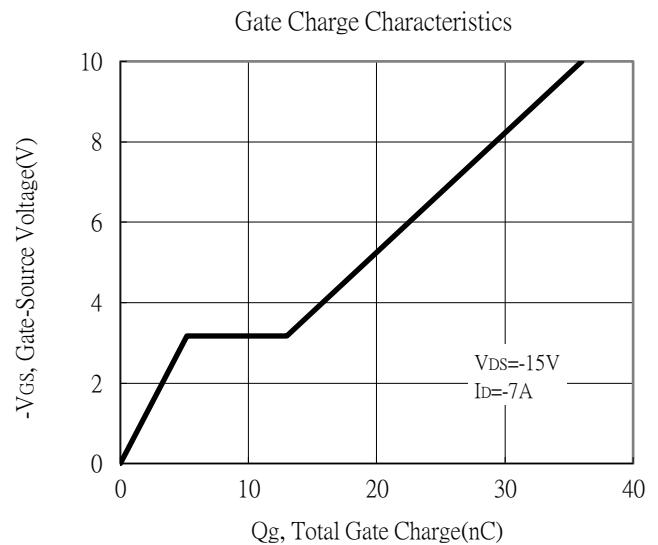
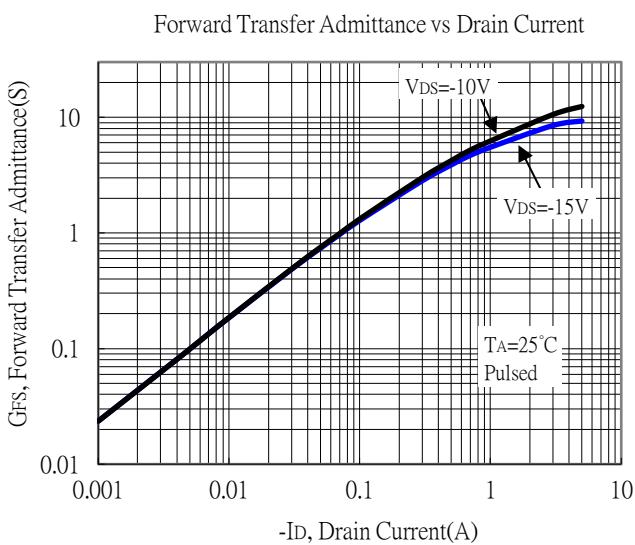
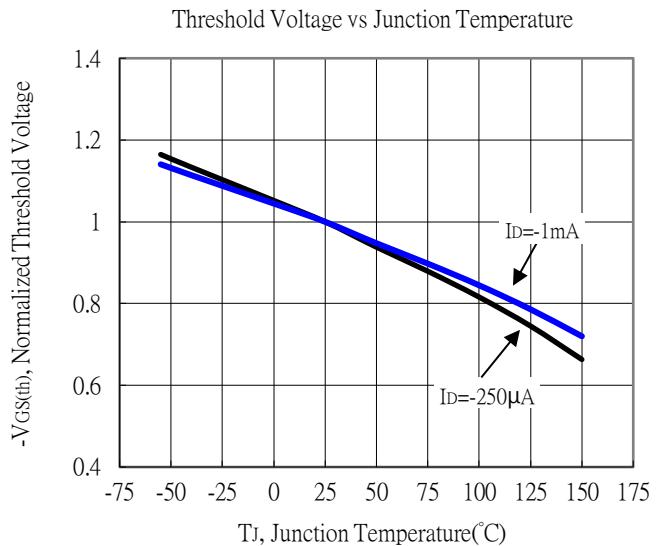
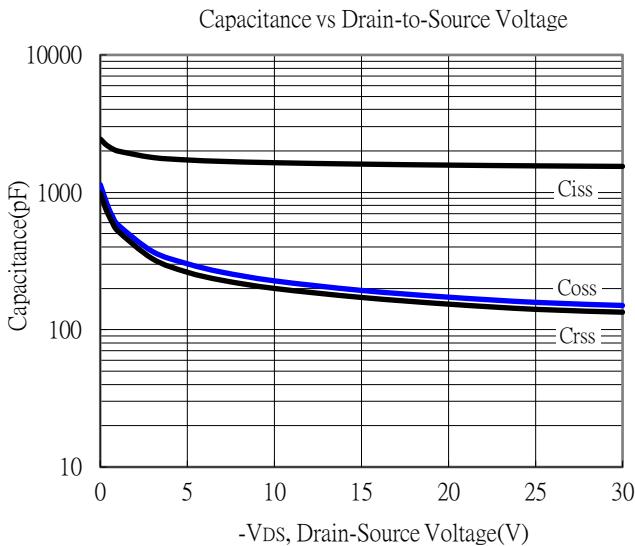
Static Drain-Source On-State Resistance vs Gate-Source Voltage



Drain-Source On-State Resistance vs Junction Temperature

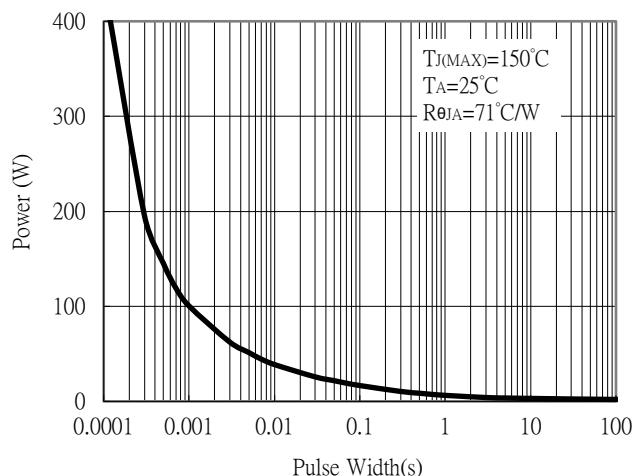


## Typical Characteristics (Cont.)

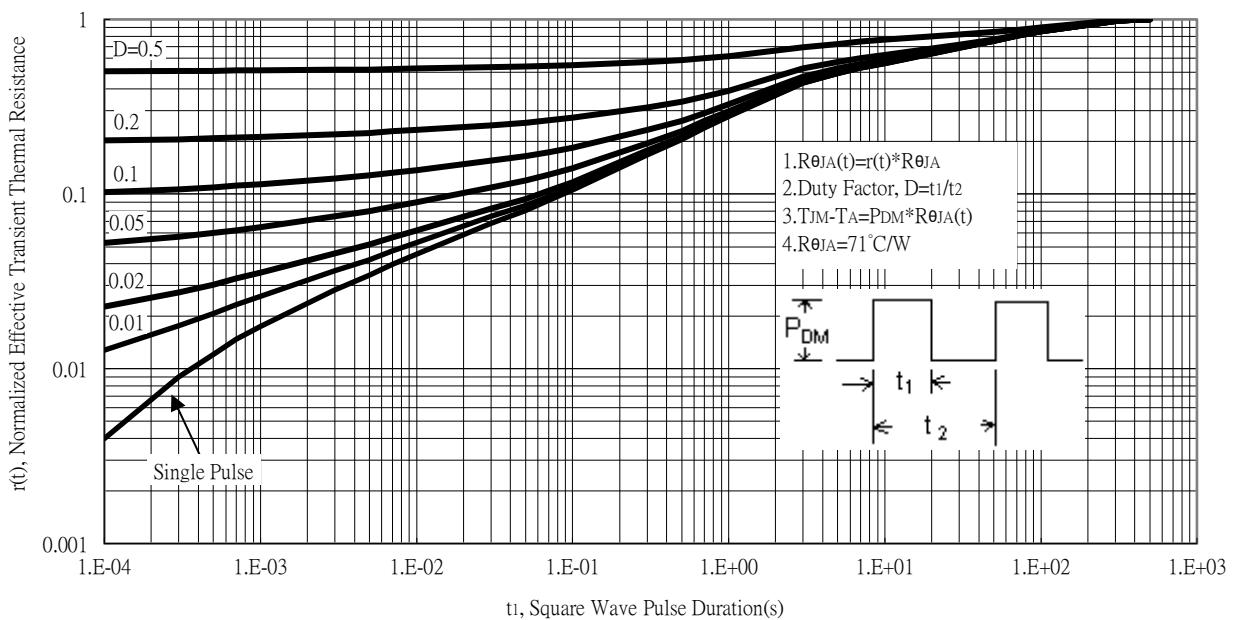


## Typical Characteristics (Cont.)

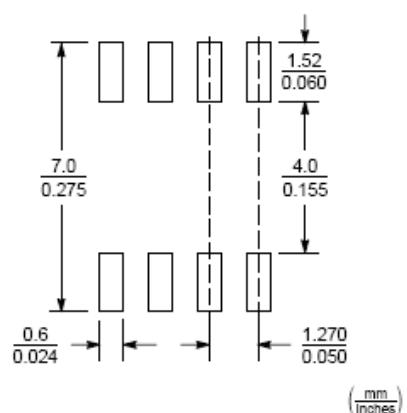
Single Pulse Power Rating, Junction to Ambient



Transient Thermal Response Curves

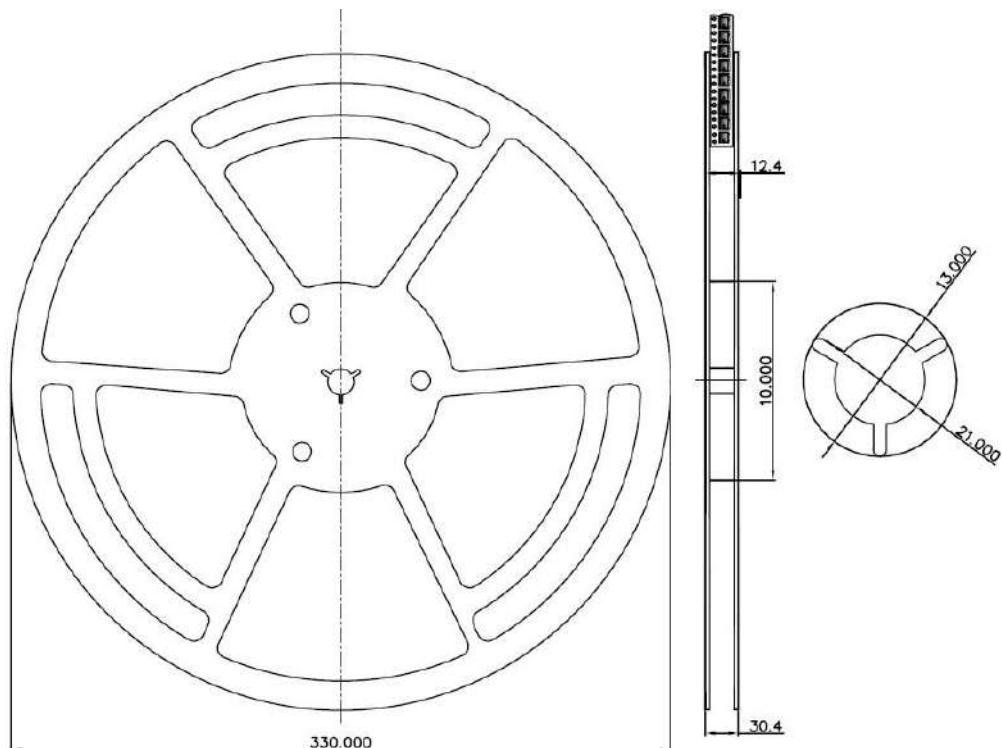


## Recommended Soldering Footprint

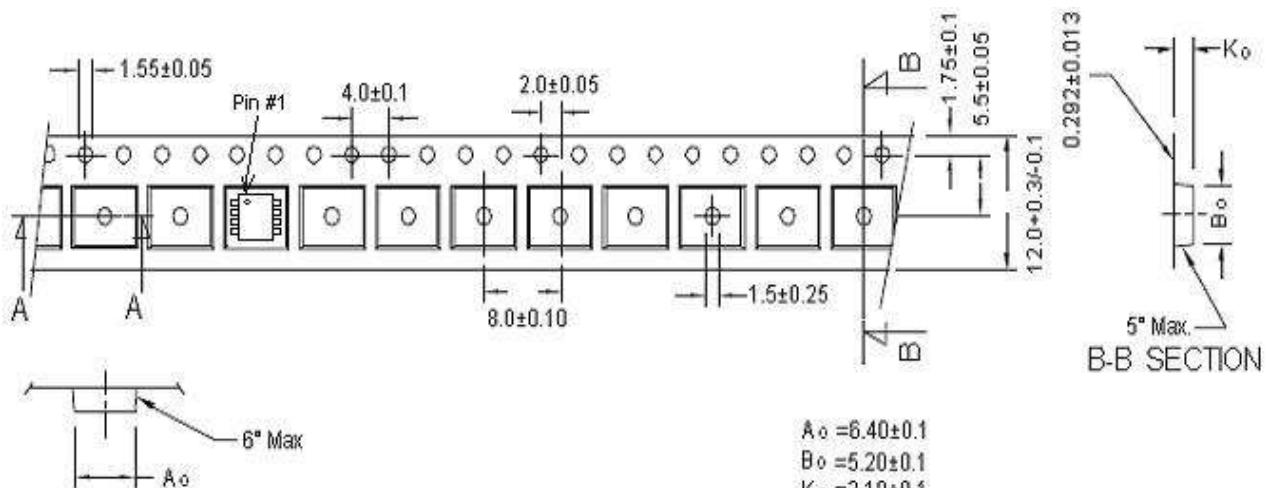


(mm)  
(inches)

## Reel Dimension



## Carrier Tape Dimension



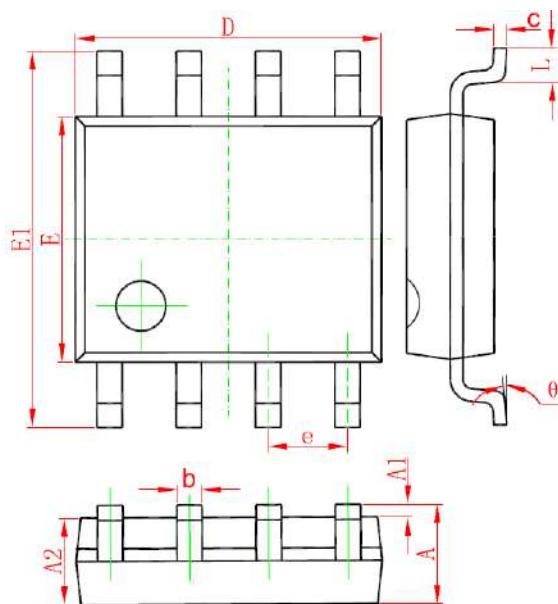
### A-A SECTION

Notes:

1. 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$ .
2. Camber not to exceed 1mm in 100mm.
3. Material: conductive black polystyrene
4. Ao & Bo measured on a plane 0.3mm above the bottom of the pocket.
5. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

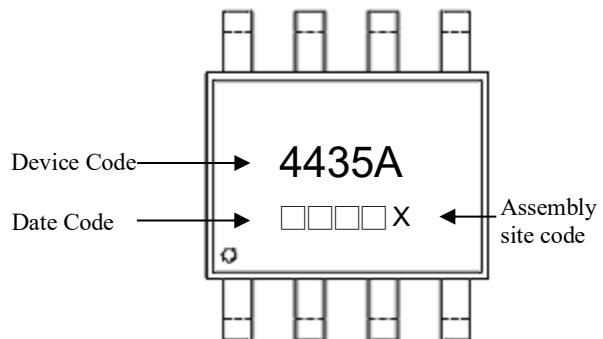
Unit : millimeter

## SOP-8 Dimension



8-Lead SOP-8 Plastic Package

### Marking:



### Date Code(counting from left to right) :

1<sup>st</sup> code: year code, the last digit of Christian year  
 2<sup>nd</sup> code : month code, Jan→A, Feb→B, Mar→C, Apr→D  
     May→E, Jun→F, Jul→G, Aug→H, Sep→J,  
     Oct→K, Nov→L, Dec→M  
 3<sup>rd</sup> and 4<sup>th</sup> codes : production serial number, 01~99

Assembly site code : blank→ site 1, G →site 2

\*: Typical

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069	E	3.800	4.000	0.150	0.157
A1	0.100	0.250	0.004	0.010	E1	5.800	6.200	0.228	0.244
A2	1.350	1.550	0.053	0.061	e	*1.270		*0.050	
b	0.330	0.510	0.013	0.020	L	0.400	1.270	0.016	0.050
c	0.170	0.250	0.006	0.010	θ	0°	8°	0°	8°
D	4.700	5.100	0.185	0.200					